# Shoulder 好达

## SHOULDER ELECTRONICS CO., LTD.

## CERAMIC RESONATOR Data Sheet

PRODUCT 产品: CERAMIC RESONATOR

MODEL NO 型 号: ZTTCS....MT

PREPARED 编 制: Fengyu

CHECKED 审核: York

APPROVED 批准:

DATE 日期: 2007-01-25

#### 1. Scope

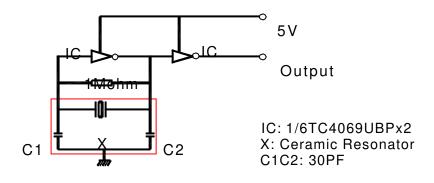
The specification is fit for ceramic resonator 6.00-13.00MHz.

#### 2. Part NO: ZTTCS ..MT

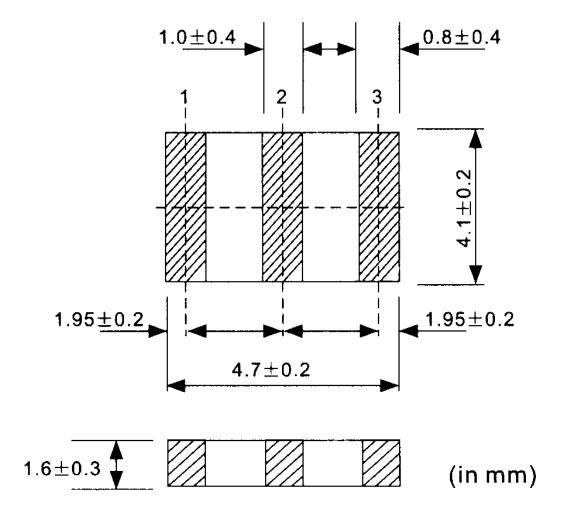
#### 3. Electrical Characteristics

No.	Item	Characteristics				
3-1	Oscillate Frequency (MHz)	6.00-13.00				
3.2	Frequency Tolerance max	±0.5%				
3.3	Resonant Impedance $\max{(\Omega)}$	30				
3.4	Built – in Capacitance (PF)	30				
3.5	Insulate Resistance min (M $\Omega$ )	100				
3.6	Withstanding Voltage D.C (V)	100 (max 5 sec)				
3.7	Voltage (1) D.C Voltage max (V) (2) Input Voltage max (V)	6 15Vp-p				
3.8	Temp characteristics of Oscillate frequency max	±0.3%				
3.9	Operating Temp Range (℃)	-20 ~ +80				
3.10	Storage Temp (℃)	-55 ~ +85				

#### 4. Test Circuit



### 5. Dimension



#### 6. Physical and Environmental Characteristics

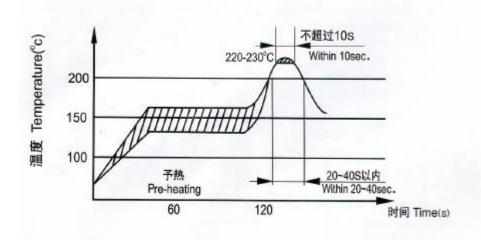
No	Item	Condition of Test	Performance			
			Requirements			
6.1	Humidity	Keep the resonator at 40±2 <sup>®</sup> C and 90-95% RH for 96 ± 4 hours. Then release the resonator into the room condition for 1 hour prior to the measurement.	It shall fulfill the specifications in Table 1.			
6.2	Vibration	Subject the resonator to vibration for 2 hours each in x,y and z axis with the amplitude of 1.5mm, the frequency shall be varied uniformly between the limits of 10-55Hz	It shall fulfill the specifications in Table 1.			
6.3	Mechanical Shock	Drop the resonator randomly onto a concrete floor from the height of 100 cm 3 times.	It shall fulfill the specifications in Table 1.			
6.4	Soldering Test	Passed through the re-flow oven under the following condition and left at room temperature for 1 hour before measurement.	It shall fulfill the specifications in Table 1.			

		Temperature at surface of the substrate Preheat 150±5°C	Time 60±10 sec.			
6.5	Solder Ability	•	10±3 sec.  r terminals into the  ±5℃ for 3±0.5 sec.	More than 95% of the terminal surface shall		
	7.0mty	301001 50111 01 2003	be covered.			
6.6	High Temperature Exposure	Subject the resona ±4 hours. Then rinto the room cond to the measuremen	It shall fulfill the specifications in Table 1.			
6.7	Low Temperature	$\pm 4$ hours. Then r	or to -20±5℃ for 96 release the resonator itions for 1 hour prior t.	It shall fulfill the specifications in Table 1.		
6.8	Temperature Cycling	minutes followed b of 85℃ for 30 m repeated 5 times w	ator to -20 ℃ for 30 by a high temperature hin. Cycling shall be with a transfer time of room condition for 1 beasurement.	It shall fulfill the specifications in Table 1.		

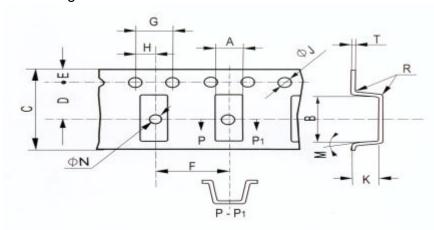
TABLE1

Item	Specification				
Oscillation Frequency Change	△F/Fo≤0.3% max				
Resonant Impedance	∆Ro≤±10 Ohm				

# 7. RECOMMENDED REFLOW SOLDERING STANDARD CONDITIONS



### 8. Packing



Tape Dimension (mm)

	A ±0.2	B ±0.2	C ±0.3	D ±0.1	E ±0.1	F ±0.1	G ±0.1	H ±0.1	ØJ ±0.1	ØN ±0.1	M max	R max	K ±0.2	T ±0.1
MG	3.8	7.8	16.0	7.5									2.1	
MT	5.0	4.4	12.0	5.5	1.75	8.0	4.0	2.0	1.5	1.6	10 <b>"</b>	0.3	1.8	0.3
MX	3.4	4.0	12.0	5.5									1.3	

Standard Package: 1Kpcs / reel